

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants: Shih-Hsiung Lin et al.

Appl. No.: 10/695,630 Filing Date: 10/27/2003

Examiner: WILLIAMS, ALEXANDER O Art Unit:2826

Docket No.: MEGP0005USA4 Confirmation No.: 5386

Title: CHIP PACKAGE WITH MULTIPLE CHIPS CONNECTED BY BUMPS

To: Commissioner for Patents
P.O. BOX 1450
Alexandria, VA 22313-1450

Subject: Information disclosure statement under 37
CFR \$1.56

Dear Sir,

This is an Information Disclosure Statement in accordance with the duty to disclose information material to patentability under 37 CFR \$1.56. The applicant wishes to make of record the document(s) listed on the accompanying form PTO/SB/08.

Since this IDS is filed after the mailing date of the first Office action but before an action which closes the prosecution in the application, consideration of the information disclosure statement is hereby requested according to 37 CFR \$1.97(c).

That each item of information contained in the information disclosure statement was first cited in an Office

communication for the related/domestic US patent application, which are no more than three months prior to the filing of the information disclosure statement.

It is respectfully requested that the examiner can consider the document(s) listed on the accompanying form PTO/SB/08 and that it be made of record in the application. The applicants sincerely hope that the examiner initials the cited reference(s) on the form and that a copy of the initialed form be sent to the applicants with the next communication from the examiner.

Respectfully submitted,

Winston Hsu

Date: 2007/2/6

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Note: Please leave a message in my voice mail if you need to talk to me. (The time in D.C. is 13 hours behind the Taiwan time, i.e. 9 AM in D.C. = 10 PM in Taiwan.)